

SCHOTTKY BARRIER DIODE

General Purpose Schottky Barrier Diode

General Description

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conductions. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.



SOT-323F

Features and Benefits

- Low forward drop voltage and low leakage current
- · Very low switching time
- Full lead (Pb)-free device and RoHS compliant device
- · Available in "Green" device



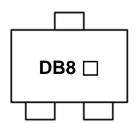
Applications

- · General purpose and high speed switching
- Protection circuit and voltage clamping

Ordering Information

Part Number	Marking Code	Package	Packaging
SDB310WKUF	DB8 □	SOT-323F	Tape & Reel

Marking Information



DB8 = Specific Device Code

☐ = Year & Week Code Marking

Pinning Information

Pin	Description	Simplified Outline	Graphic Symbol
1	Anode (Diode 1)	3	
2	Anode (Diode 2)		 **
3	Common Cathode	1 2	

Absolute Maximum Ratings (T_{amb}=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Peak reverse voltage	V_{RM}	40	V
DC reverse voltage	V _R	30	V
Repetitive peak forward current	I _{FRM}	0.5	А
Forward current	l _F	0.2	А
Non-repetitive peak forward surge current(t=10ms)	I _{FSM}	2	А
Power dissipation 1)	P _D	150	mW

¹⁾ Device mounted on FR-4 board with recommended pad layout.

Thermal Characteristics (T_{amb}=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Thermal resistance, junction to ambient 1)	R _{th(j-a)}	833	°C/W
Operating junction temperature	Tj	150	°C
Storage temperature range	T _{stg}	-55 ~ 150	°C

¹⁾ Device mounted on FR-4 board with recommended pad layout.

Electrical Characteristics (T_{amb}=25°C, Unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward voltage ²⁾	V _{F(1)}	I _F =10mA	-	-	0.4	V
	$V_{F(2)}$	I _F =30mA	-	-	0.5	V
Reverse leakage current 3)	I _R	V _R =30V	-	-	1	μΑ
Total capacitance	C _T	V _R =1V, f=1MHz	-	-	10	pF
Reverse recovery time	t _{rr}	I _F = I _R =10mA, I _{R(REC)} = 1mA	-	-	5	ns

²⁾ Pulse test: $t_P \le 380 \,\mu\text{s}$, Duty cycle $\le 2\%$

 $^{^{3)}}$ Pulse test: $t_P \le 5 \text{ms}$, Duty cycle $\le 2\%$

Rating and Characteristic Curves

Fig. 1) Typical Forward Characteristics

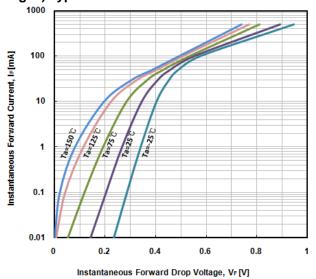


Fig. 2) Typical Reverse Characteristics

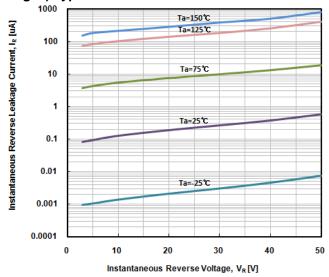


Fig. 3) Typical Total Capacitance Characteristics

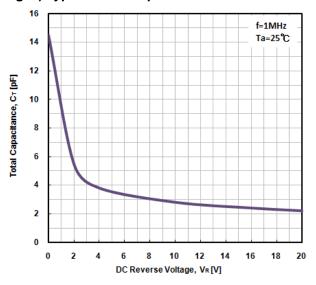


Fig. 4) Power dissipation vs. Ambient temperature

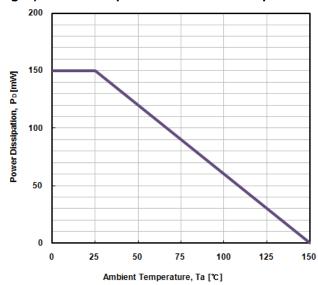
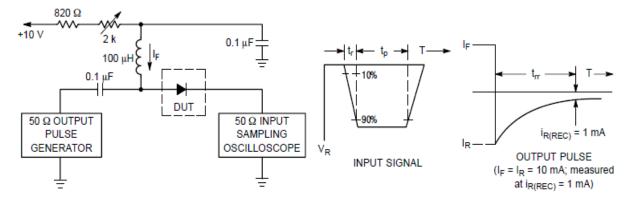
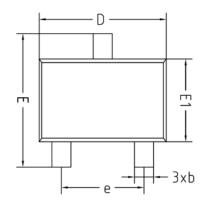
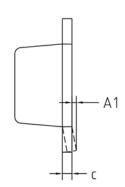


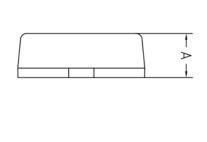
Fig. 5) Reverse recovery time equivalent test circuit



Package Outline Dimensions

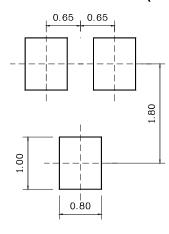






SYMBOL	1	NOTE		
STRIBUL	MINIMUM	NOMINAL	MAXIMUM	NUTE
Α	0.60	-	0.80	
A1	0.00	-	0.10	
Ь	0.30	-	0.40	
С	0.08	-	0.16	
D	1.90	2.00	2.10	
Е	1.95	2.10	2.25	
E1	1.20	1.30	1.40	
е		1.30BS	C	

X Recommend PCB solder land (Unit : mm)



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